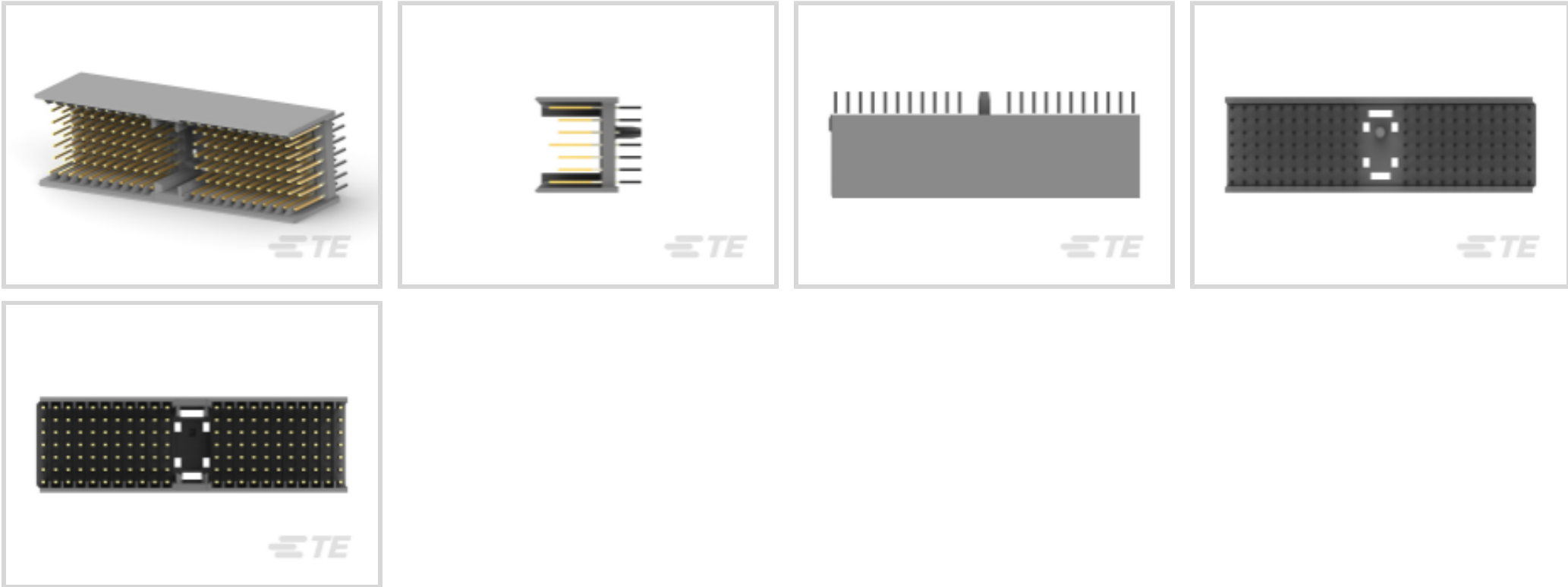




Connectors > PCB Connectors > Backplane Connectors > Hard Metric Connectors



PCB Connector Assembly Type: **PCB Mount Header**

Data Rate: **≤1 Gb/s**

Number of Columns: **22**

Number of Rows: **7**

Backplane Architecture: **Mezzanine**

Features

Product Type Features

| | |
|-----------------------------------|-------------------------|
| Backplane Interface Type | 2mm HM |
| Ground Component Type | Ground Return Shielding |
| PCB Connector Assembly Type | PCB Mount Header |
| Connector System | Board-to-Board |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |

Configuration Features

| | |
|----------------------------|---------------------|
| Rows Loaded | A, B, C, D, E, F, Z |
| Number of Signal Positions | 110 |
| Number of Columns | 22 |
| Number of Rows | 7 |
| Backplane Architecture | Mezzanine |
| Number of Positions | 154 |
| PCB Mount Orientation | Vertical |



Signal Characteristics

| | |
|-------------------|----------|
| Crosstalk Version | Standard |
| Data Rate | ≤1 Gb/s |

Contact Features

| | |
|--|---------------------------|
| Contact Mating Area Length | 5.25 mm, 6.75 mm, 8.25 mm |
| Feedthrough Post Length | 3.7 mm |
| Contact Type | Pin |
| Contact Underplating Material | Nickel |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Phosphor Bronze |
| CompactPCI Designation | P1/P4 |
| Contact Mating Area Plating Material | Gold |
| Contact Mating Area Plating Material Thickness | .38 μm[15 μin] |
| Contact Current Rating (Max) | 1.5 A |

Mechanical Attachment

| | |
|-------------------------|----------------------|
| Front Mating Level | Level 1 |
| Mating Alignment Type | Multi-Purpose Center |
| Connector Mounting Type | Board Mount |

Housing Features

| | |
|--------------------|----------------|
| Housing Material | Polyester - GF |
| Centerline (Pitch) | 2 mm[.078 in] |
| Housing Color | Gray |

Dimensions

| | |
|-------------------------|-------|
| Backplane Module Length | 50 mm |
|-------------------------|-------|

Usage Conditions

| | |
|-----------------------------|----------------------------|
| Operating Temperature Range | -55 – 125 °C[-67 – 257 °F] |
|-----------------------------|----------------------------|

Operation/Application

| | |
|---------------------|----------------|
| Shielded | Yes |
| Circuit Application | Power & Signal |

Industry Standards

| | |
|-------------------------------|----------|
| UL Flammability Rating | UL 94V-0 |
| AdvancedTCA Specified Product | No |



Packaging Features

| | |
|--------------------|------|
| Packaging Quantity | 10 |
| Packaging Method | Tube |

Other

| | |
|---------|-----------------------|
| Comment | Row Configuration 5+2 |
|---------|-----------------------|

Product Compliance

For compliance documentation, visit the product page on [TE.com](#)>

| | |
|---|---|
| EU RoHS Directive 2011/65/EU | Compliant |
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUN 2020 (209) Candidate List Declared Against: JUN 2020 (209) Does not contain REACH SVHC |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Not applicable for solder process capability |

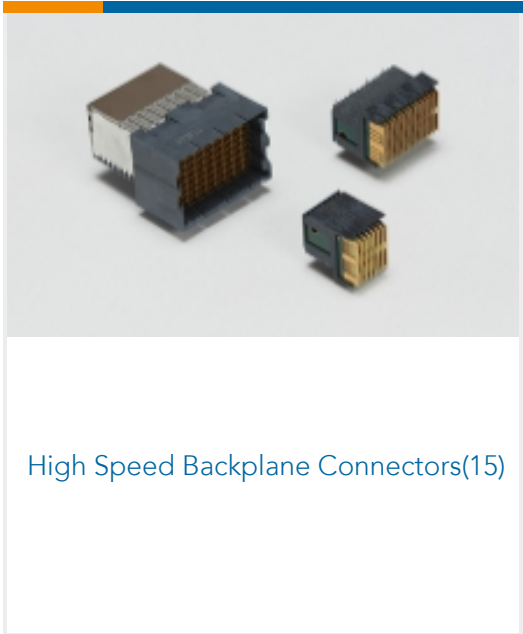
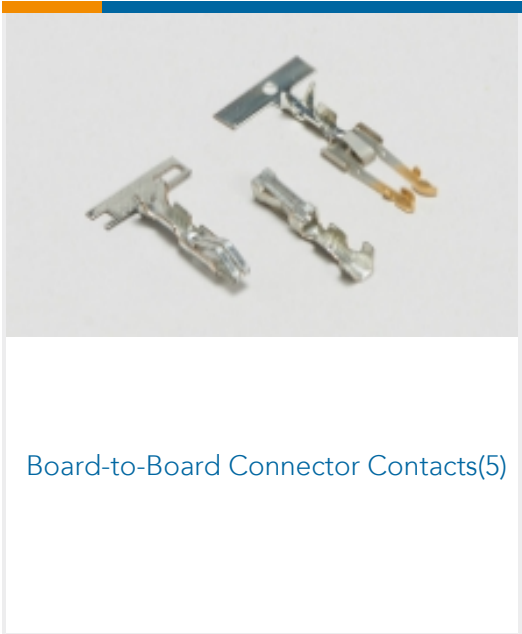
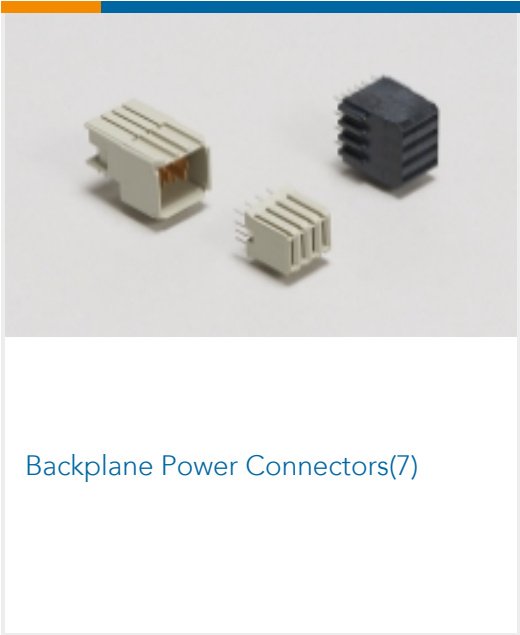
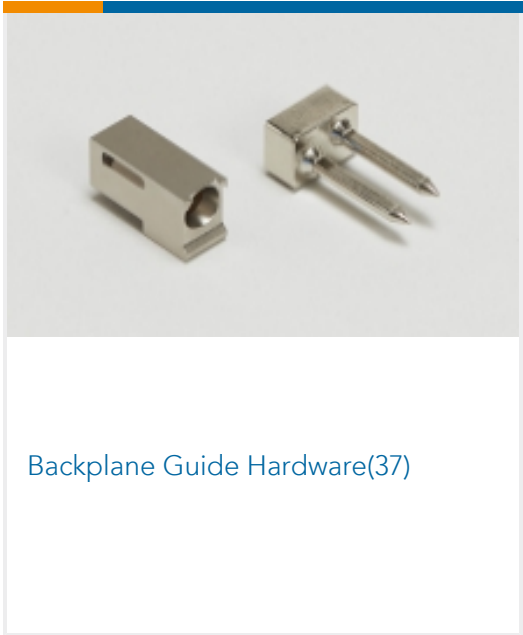
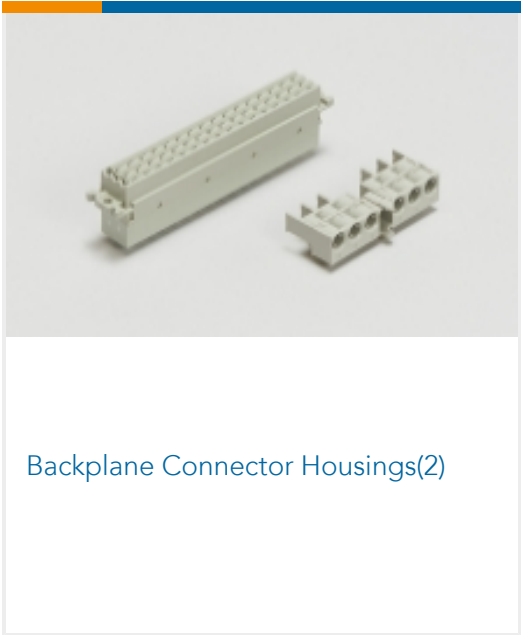
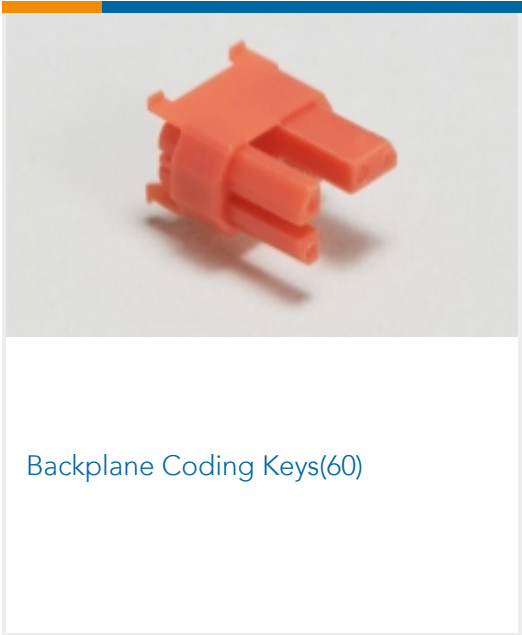
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) ‘Guidance on requirements for substances in articles’ posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Also in the Series | Z-PACK 2mm HM



Customers Also Bought





TE Model / Part #1410186-1
MULTIGIG RT T2 .8" BP H-LFT

TE Model / Part #1-1469492-1
MULTIGIG RT 9MM GUIDE/ESD 0 DEG

TE Model / Part #1410140-1
MULTIGIG RT T2 .8" BP FULL CNT

TE Model / Part #5120527-1
1FHP,64,30A/S,S,N,S10,12,13,15

TE Model / Part #1-1469492-9
MULTIGIG RT 9MM GUIDE/ESD UNKE

TE Model / Part #5120521-1
1FHR,64,30A/S,S,N,S08,09,10

Documents

Product Drawings

Z-PACK/A M-HDR 154P.

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5188834-1_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5188834-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5188834-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

Application Specification

English

Product Environmental Compliance

MD_5188834-1_082720182251_dmtec

English

MD_5188834-1_082720182251_dmtec

English

5188834-1

Z-PACK 2mm HM, Hard Metric Backplane Connectors, PCB Mount Header, ≤1 Gb/s,
22 Column, 7 Row, Mezzanine, Board-to-Board, 154 Position

